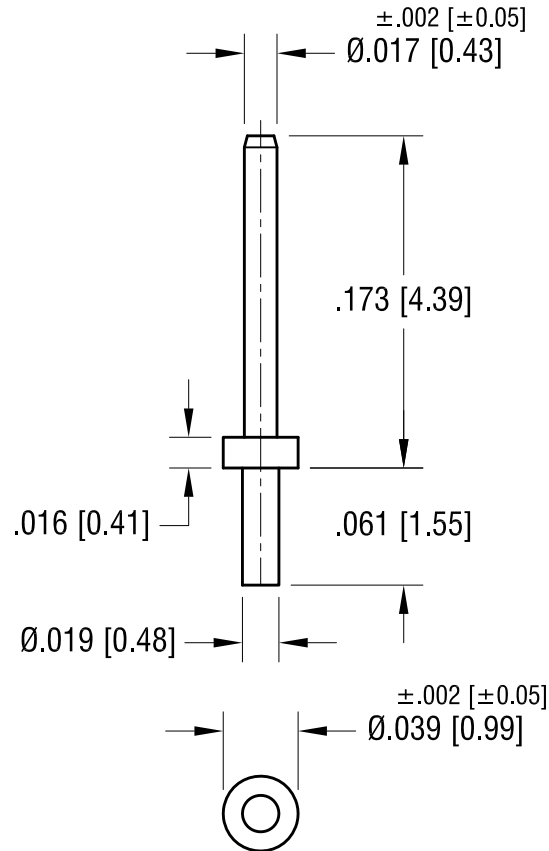


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ACTUAL SIZE



NOTE:
1. MOUNTING HOLE .022 [0.56] DIA.

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PART NAME			
MICRO PIN, SOLDER MOUNT			
MATERIAL			
BRASS			
FINISH		DRN BY	DATE
GOLD PLATE		BOONE	4.03.07
		APP'D	SCALE
		RH	10X
TOLERANCES	INCH [MM]	CODE	DWG NO.
DECIMAL	$\pm .005$ [± 0.13]	C	1378-1
ANGULAR	$\pm 1^\circ$		
UNLESS OTHERWISE SPECIFIED			

DATE	DESCRIPTION	REV.